



模块 13

活动：定时器



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问题1

MSP432上有一个32位定时器。如果此定时器的时钟频率为12 MHz，那么创建周期性中断的最慢时间是多少？

问题2

在32位定时器上读取MSP432数据表。编写使用此定时器执行周期性任务的软件，Task（），每秒一次。

问题3

使用Timer A2示例而不更改Timer A2初始化，从讲座幻灯片，每秒运行Task1一次，Task2每秒运行两次，Task3每秒运行三次。要减少延迟，请将其设置为在同一ISR期间不运行任何两个任务。假设SMCLK为12 MHz。

问题4

编写软件以产生4个周期为1ms的PWM周期，但具有独立的占空比。

问题5

列出可用于生成PWM输出的所有MSP432引脚。

问题6

读取Timer_A模块的MSP432数据表。描述该软件系统的特性，假设主程序调用TimerA0_Init然后启用中断。

```
#define N1 1000
#define N2 1500
#define N3 2000
void TimerA0_Init(void){
    TAOCTL &= ~0x0030;           // 0) halt Timer A0
    TAOCTL = 0x0240;             // 1) SMCLK, divide by 2
    TAOEX0 = 0x0005;             //   divide by 6
    TAOCTL1 = 0x0010;           // 2) compare mode, arm CCIFG
    TAOCTL2 = 0x0010;           //   compare mode, arm CCIFG
    TAOCTL3 = 0x0010;           //   compare mode, arm CCIFG
    TA0CCR1 = N1/2;              // 3) time of first interrupt
    TA0CCR2 = N2/2;              //
    TA0CCR3 = N3/2;              //
    NVIC_IPR2 = (NVIC_IPR2&0xFFFF00FF)|0x00004000;
    NVIC_ISER0 = 0x00000200;     // 5) enable interrupt 9
    TAOCTL |= 0x0024;            // 6) reset and start
}

void TA0_N_IRQHandler(void){
    if(TA0CTL1&0x0001){
        TA0CTL1 &= ~0x0001;     // acknowledge interrupt 1
        TA0CCR1 = TA0CCR1+N1;    // set up for next time
        Task1();                 // execute user task
    }
    if(TA0CTL2&0x0001){
        TA0CTL2 &= ~0x0001;     // acknowledge interrupt 2
        TA0CCR2 = TA0CCR2+N2;    // set up for next time
        Task2();                 // execute user task
    }
    if(TA0CTL3&0x0001){
        TA0CTL3 &= ~0x0001;     // acknowledge interrupt 3
        TA0CCR3 = TA0CCR3+N3;    // set up for next time
        Task3();                 // execute user task
    }
}
```

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